

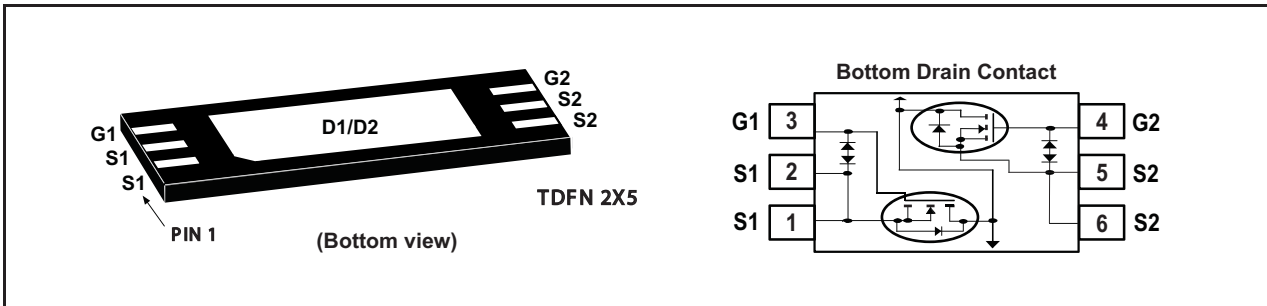


Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V _{DSS}	I _D	R _{DS(ON)} (mΩ) Max
24V	8.6A	14.0 @ V _{GS} =4.5V
		14.3 @ V _{GS} =4.0V
		14.5 @ V _{GS} =3.7V
		16.5 @ V _{GS} =3.1V
		20.0 @ V _{GS} =2.5V

FEATURES

- Super high dense cell design for low R_{DS(ON)}.
- Rugged and reliable.
- Surface Mount Package.
- ESD Protected.



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Symbol	Parameter	Limit	Units
V _{DS}	Drain-Source Voltage	24	V
V _{GS}	Gate-Source Voltage	±12	V
I _D	Drain Current-Continuous ^a	T _A =25°C	8.6
		T _A =70°C	6.9
I _{DM}	-Pulsed ^b	42	A
P _D	Maximum Power Dissipation ^a	T _A =25°C	1.67
		T _A =70°C	1.07
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150	°C

THERMAL CHARACTERISTICS

R _{θJA}	Thermal Resistance, Junction-to-Ambient ^a	75	°C/W
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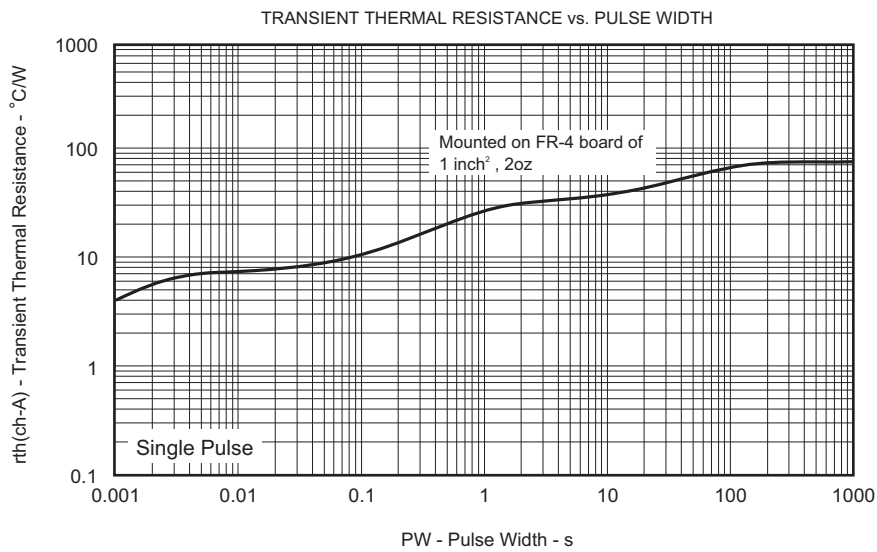
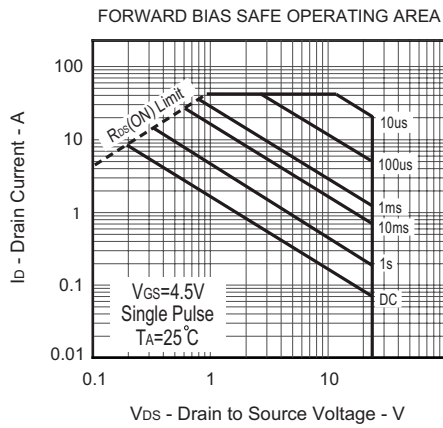
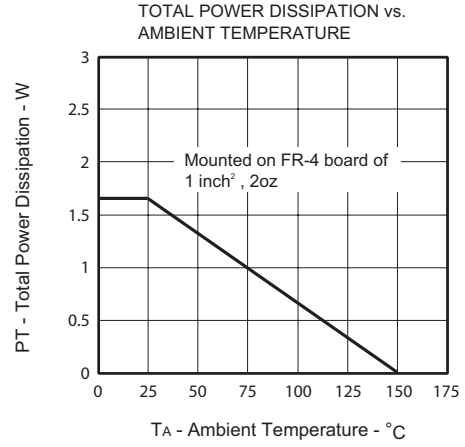
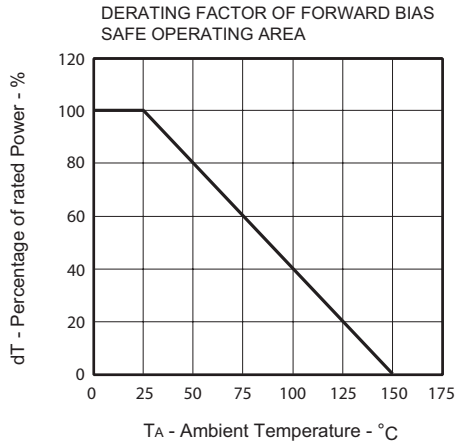
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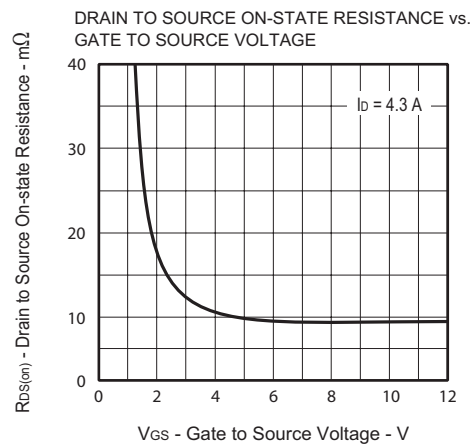
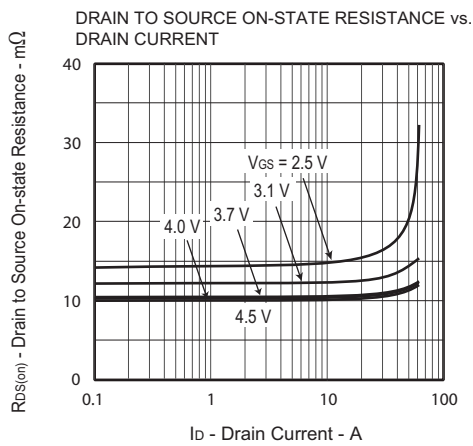
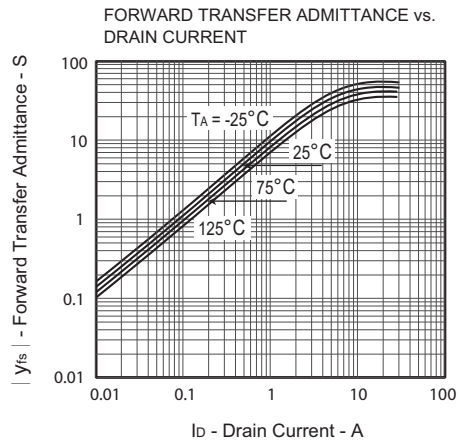
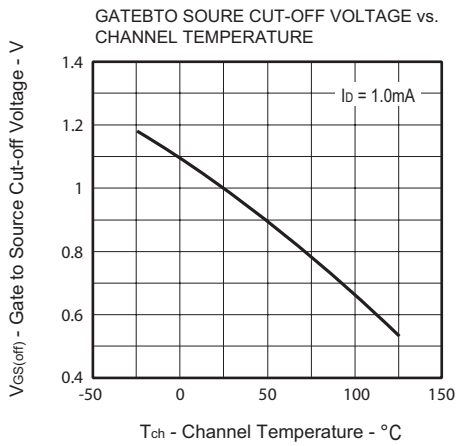
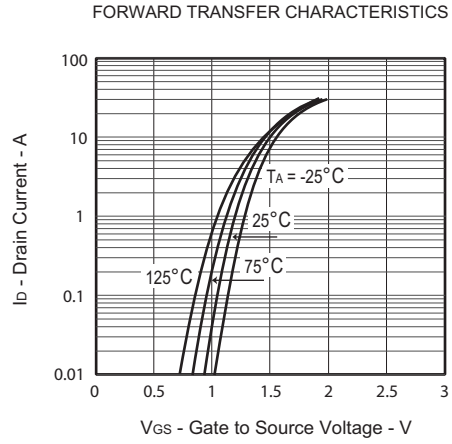
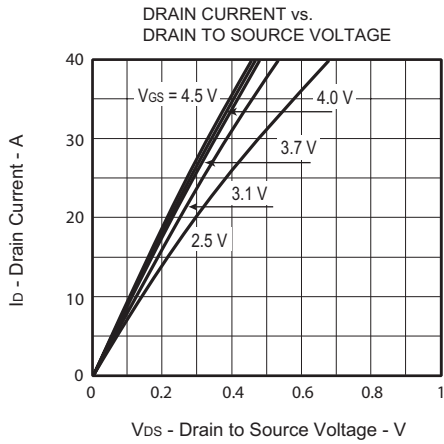
Ver 3.2

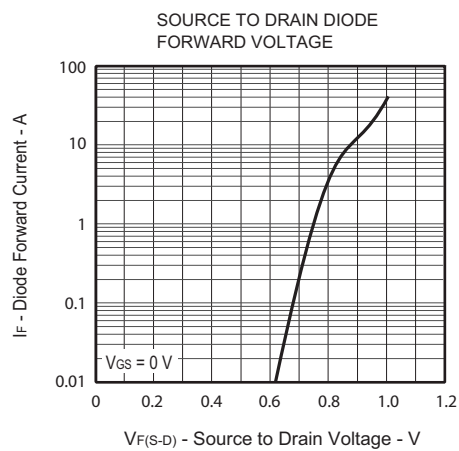
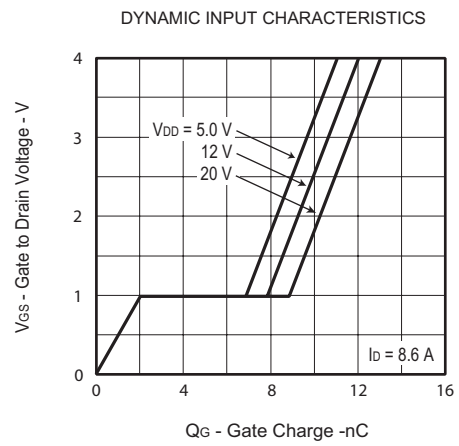
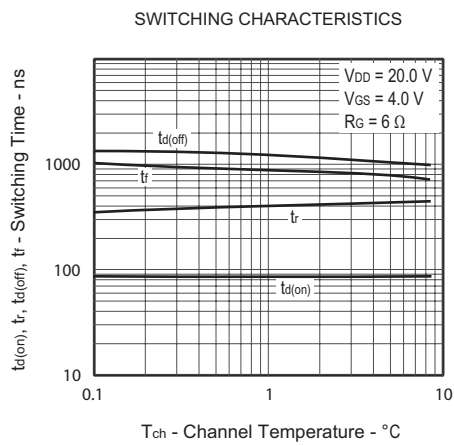
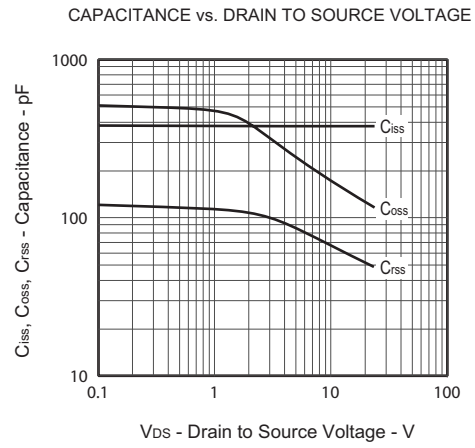
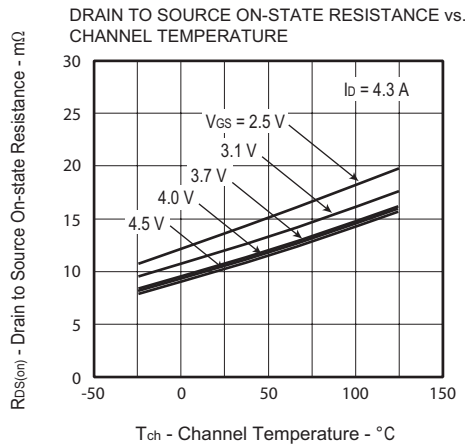
ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	24			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =20V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±12V , V _{DS} =0V			±10	uA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =1.0mA	0.5	0.8	1.5	V
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =4.5V , I _D =4.3A	9.0	11.5	14.0	m ohm
		V _{GS} =4.0V , I _D =4.3A	9.3	11.8	14.3	m ohm
		V _{GS} =3.7V , I _D =4.3A	9.5	12.0	14.5	m ohm
		V _{GS} =3.1V , I _D =4.3A	10.0	13.0	16.5	m ohm
		V _{GS} =2.5V , I _D =4.3A	12.5	15.0	20.0	m ohm
g _{FS}	Forward Transconductance	V _{DS} =10V , I _D =4.3A		33		S
DYNAMIC CHARACTERISTICS ^c						
C _{ISS}	Input Capacitance	V _{DS} =10V, V _{GS} =0V f=1.0MHz		380		pF
C _{OSS}	Output Capacitance			180		pF
C _{RSS}	Reverse Transfer Capacitance			67		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =20V I _D =4.3A		80		ns
t _r	Rise Time			435		ns
t _{D(OFF)}	Turn-Off Delay Time	V _{GS} =4.0V R _{GEN} =6 ohm		1150		ns
t _f	Fall Time			725		ns
Q _g	Total Gate Charge	V _{DS} =20V, I _D =8.6A, V _{GS} =4.0V		13		nC
Q _{gs}	Gate-Source Charge			2		nC
Q _{gd}	Gate-Drain Charge			6.9		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =8.6A		0.86	1.2	V
Notes						
a.Surface Mounted on FR4 Board, t ≤ 10sec.						
b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.						
c.Guaranteed by design, not subject to production testing.						

Apr,20,2011







PACKAGE OUTLINE DIMENSIONS

